

International Symposium of Flexible and Stretchable Electronics (ISFSE16)

29-30 June 2016, Wuhan, China

Welcome Message

On behalf of the organizing committee, we would like to invite you to International Symposium of Flexible and Stretchable Electronics, which will take place in Wuhan, China from June 29-30, 2016.

As a rapid developing field, flexible and stretchable electronics offers unsurpassed features for new generation electronics. ISFSE16 creates an exclusive exchange platform addressing manufacturers and users of a technology of the future across a wide range of industry community, and it offers a unique opportunity to gather the researchers together to exchange the information, forge the ideas, and initialize collaboration. Quite a few scholars have been confirmed to join us.

The major areas of activity in the flexible and stretchable electronics solicited and expected at this symposium include but are not limited to:

- Mechanical design: **Mechanics and reliability**
- Materials characterization: Electronic ink, nanomaterials
- **Fabrication engineering, process development and integration:** Advanced Printing, IC packaging, Transfer Printing
- Applications: Wearable electronics, Compliant energy sources, Flexible display, Smart skin
- **New soft systems:** Self-healing systems, Biodegradable systems, Edible electronics
- Synthetic approaches, **Organic electronics**
- Instrumentation and manufacturing

Presentation and Recommendation

High quality papers from this symposium will be selected to be published in a special issue of MDPI

Micromachines Journal

Organizing Committee

General Chairs



Zhong Lin Wang, GIT, USA



Youlun Xiong, HUST, China

Program Chairs

Zhigang Wu
Rong Chen
YongAn Huang

Important Dates

Abstract Submission Deadline:

April 15, 2016

Acceptance Notification Deadline:

May 10, 2015

Conference date:

June 29-30, 2016

Contact Us

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E-mail:

sherryge@hotmail.com

Invited Scholars



Prof. Yonggang Huang
Northwestern University, USA



Prof. Zhouping Yin
HUST, China



Prof. Thomas Löher
Fraunhofer IZM and TU, Berlin



Prof. Jan Vanfleteren
IMEC, Belgium



Prof. Dae-Hyeong Kim
Seoul National University, Korea



Prof. Michael Dickey
NCSU, USA



Prof. Yong Zhu
NCSU, USA



Prof. Darren Lipomi
UCSD, USA



Prof. Martin Kaltenbrunner
JKU, Austria



Prof. Aaron Mezzo
Rutgers, USA



Prof. Xuanhe Zhao
MIT, USA



Prof. Haixia Zhang
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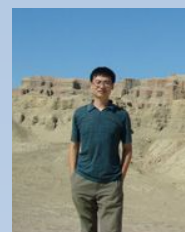
Prof. Weizheng Yuan
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Prof. Meifang Zhu
DHU, China



Prof. Shaoxing Qu
ZJU, China



Prof. Xue Feng
Tsinghua University, China

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